SCES351F - JUNE 2001 - REVISED OCTOBER 2002

- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- Supports 5-V V_{CC} Operation
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 4.6 ns at 3.3 V
- Low Power Consumption, 10-µA Max I_{CC}
- ±24-mA Output Drive at 3.3 V
- **I**off Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DBV OR DCK PACKAGE (TOP VIEW) NC □ v_{cc} Α GND

NC - No internal connection

YEA OR YZA PACKAGE (BOTTOM VIEW)



description/ordering information

This single Schmitt-trigger buffer is designed for 1.65-V to 5.5-V V_{CC} operation.

The SN74LVC1G17 contains one buffer and performs the Boolean function Y = A. The device functions as an independent buffer, but because of Schmitt action, it may have different input threshold levels for positive-going (V_{T+}) and negative-going (V_{T-}) signals.

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

TA	PACKAGE [†]	PACKAGE [†]			
	NanoStar™ WCSP (DSBGA) – YEA (Lead)	Tape and reel	SN74LVC1G17YEAR	C7	
-40°C to 85°C	NanoFree™ WCSP (DSBGA) – YZA (Lead-free)	Tape and reel	SN74LVC1G17YZAR	0/_	
	SOT (SOT-23) – DBV	Tape and reel	SN74LVC1G17DBVR	C17_	
	SOT (SC-70) – DCK	Tape and reel	SN74LVC1G17DCKR	C7_	

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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[‡]DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site. YEA/YZA: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site.

FUNCTION TABLE

INPUT A	OUTPUT Y
Н	Н
L	L

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	–0.5 V to 6.5 V
Input voltage range, V _I (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, V _O	
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	–0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I _{OK} (V _O < 0)	
Continuous output current, IO	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3): DBV package	206°C/W
DCK package	252°C/W
YEA/YZA package	154°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V_{CC} is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



SN74LVC1G17 SINGLE SCHMITT-TRIGGER BUFFER

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recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
V	Cumphyvoltogo	Operating	1.65	5.5	V
VCC	Supply voltage	Data retention only	1.5		V
٧ _I	Input voltage		0	5.5	V
٧o	Output voltage		0	VCC	V
		V _{CC} = 1.65 V		-4	
		$V_{CC} = 2.3 V$		-8	
loh	High-level output current	V3 V		-16	mA
		VCC = 3 V		-24	
		V _{CC} = 4.5 V		-32	
		V _{CC} = 1.65 V		4	
		V _{CC} = 2.3 V		8	
I_{OL}	Low-level output current	Voc - 3 V		16	mA
		V _{CC} = 3 V		24	
		$V_{CC} = 4.5 \text{ V}$		32	
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	vcc	MIN	TYPT MAX	UNIT		
		1.65 V	0.76	1.13			
V _{T+}		2.3 V	1.08	1.56			
Positive-going input		3 V	1.48	1.92	V		
threshold voltage		4.5 V	2.19	2.74			
		5.5 V	2.65	3.33			
		1.65 V	0.35	0.59			
V _T _		2.3 V	0.56	0.88			
Negative-going input		3 V	0.89	1.2	V		
threshold voltage		4.5 V	1.51	1.97			
		5.5 V	1.88	2.4			
		1.65 V	0.36	0.64			
ΔV_{T}		2.3 V	0.45	0.78			
Hysteresis		3 V	0.51	0.83	V		
$(V_{T+} - V_{T-})$		4.5 V	0.58	0.93			
		5.5 V	0.69	1.04			
	I _{OH} = -100 μA	1.65 V to 4.5 V	V _{CC} -0.1				
	I _{OH} = -4 mA	1.65 V	1.2				
Vari	$I_{OH} = -8 \text{ mA}$	2.3 V	1.9		V		
VOH	I _{OH} = -16 mA	3 V	2.4		V		
	I _{OH} = -24 mA	3 V	2.3				
	$I_{OH} = -32 \text{ mA}$	4.5 V	3.8				
	I _{OL} = 100 μA	1.65 V to 4.5 V		0.1			
	I _{OL} = 4 mA	1.65 V		0.45			
Vol	$I_{OL} = 8 \text{ mA}$	2.3 V		0.3	V		
VOL	I _{OL} = 16 mA	3 V		0.4	V		
	I _{OL} = 24 mA	3 v		0.55			
	I _{OL} = 32 mA	4.5 V		0.55			
I _I A input	V _I = 5.5 V or GND	0 to 5.5 V		±5	μΑ		
loff	V _I or V _O = 5.5 V	0		±10	μΑ		
Icc	$V_I = 5.5 \text{ V or GND}, \qquad I_O = 0$	1.65 V to 5.5 V		10	μΑ		
ΔlCC	One input at $V_{CC} = 0.6 \text{ V}$, Other inputs at V_{CC} or GND	3 V to 5.5 V		500	μΑ		
Ci	V _I = V _{CC} or GND	3.3 V		4.5	pF		

[†] All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended operating free-air temperature range, C_L = 15 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} =		V _{CC} = ± 0.		V _{CC} = ± 0.		V _{CC} :		UNIT
	(1001-01)	(001F01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
^t pd	А	Υ	2.8	9.9	1.6	5.5	1.5	4.6	0.9	4.4	ns



SN74LVC1G17 SINGLE SCHMITT-TRIGGER BUFFER

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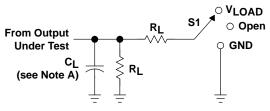
switching characteristics over recommended operating free-air temperature range, C_L = 30 pF or 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = ± 0.1		V _{CC} = ± 0.		V _{CC} =	: 3.3 V 3 V	V _{CC} :		UNIT
	(INI O1)	(001F01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{pd}	A	Y	3.8	11	2	6.5	1.8	5.5	1.2	5	ns

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	$V_{CC} = 1.8 V$	$V_{CC} = 2.5 V$	$V_{CC} = 2.5 \text{ V} V_{CC} = 3.3 \text{ V}$		UNIT
PARAMETER		TEST CONDITIONS	TYP	TYP	TYP	TYP	ONIT
C _{pd}	Power dissipation capacitance	f = 10 MHz	20	21	22	26	pF

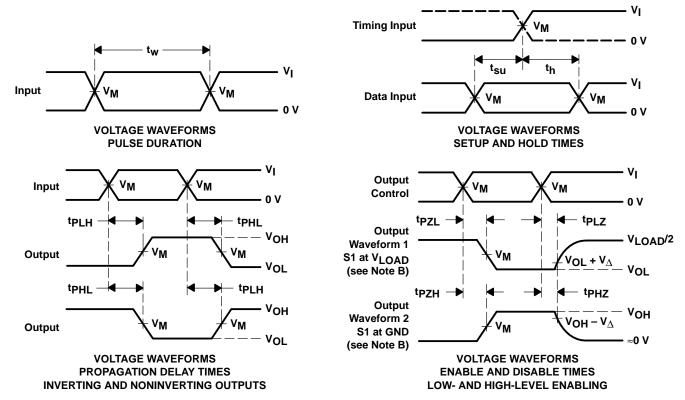
PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

	CUIT	

.,	INF	INPUTS		.,		_	.,
VCC	٧ _I	t _r /t _f	VM	VLOAD	CL	RL	$v_{\scriptscriptstyle\Delta}$
1.8 V \pm 0.15 V	VCC	≤2 ns	V _{CC} /2	2×V _{CC}	15 pF	1 M Ω	0.15 V
2.5 V \pm 0.2 V	VCC	≤2 ns	V _{CC} /2	2×V _{CC}	15 pF	1 M Ω	0.15 V
3.3 V \pm 0.3 V	3 V	≤2.5 ns	1.5 V	6 V	15 pF	1 M Ω	0.3 V
5 V \pm 0.5 V	VCC	≤2.5 ns	V _{CC} /2	2×V _{CC}	15 pF	1 M Ω	0.3 V



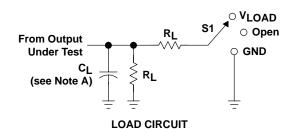
NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{O} = 50 \Omega$.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

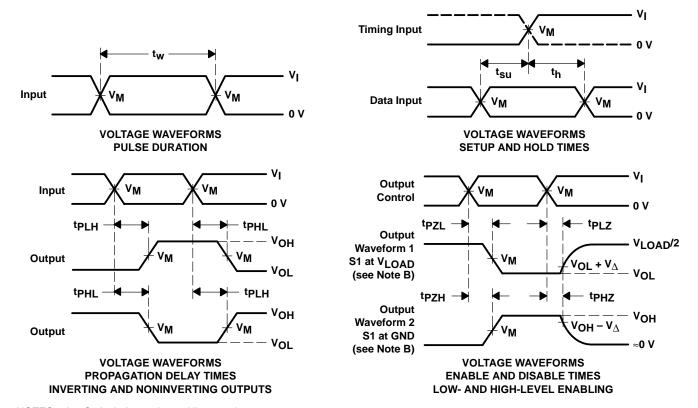


PARAMETER MEASUREMENT INFORMATION



TEST	S 1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

.,	INPUTS		.,			_	.,
VCC	٧ _I	t _r /t _f	VM	VLOAD	CL	RL	$oldsymbol{V}_\Delta$
1.8 V \pm 0.15 V	VCC	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	VCC	≤2 ns	V _{CC} /2	2×VCC	30 pF	500 Ω	0.15 V
3.3 V \pm 0.3 V	3 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
5 V \pm 0.5 V	VCC	≤2.5 ns	V _{CC} /2	2×V _{CC}	50 pF	500 Ω	0.3 V



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_Ω = 50 Ω.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpLH and tpHL are the same as tpd.
 - H. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms



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